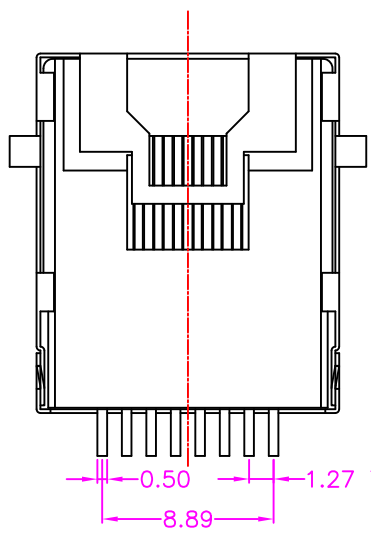


P.C.B. LAYOUT
TOP VIEW ±0.05



MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)
 SHELL: COPPER ALLOY, NICKEL PLATING
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA
 TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 1.5 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 30m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -40°C~+85°C

PART NUMBER:
3MJGB - 8 8 * T - 1 * 1

SERIES — 8 POSITION & 8 CONTACT

CONTACT PLATED OPTION —
 1: GOLD FLASH
 3: 3u" GOLD
 5: 5u" GOLD
 7: 15u" GOLD
 9: 30u" GOLD
 11: 6u" GOLD

TIN PLATING ON SOLDER TAIL

PACKAGE OPTION
 1: TRAY
 2: TAPE REEL

A	RELEASE	2013.2.27
REV.	DESCRIPTION	DATE

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TOLERANCES		MODULAR JACK SERIES			
X.X ±0.3		TITLE RJ45, PCB MOUNT, SIDE ENTRY SMT, METAL SHIELD			
X.XX ±0.2		DRAWN BY		CHECKED BY	APPROVED BY
X.XXX ±0.1		Janice		Lion	Benson
Angle ±5°		UNIT	SCALE	SIZE	DRAW NO.
		10108	MM	NONE	A4
		REV.	Sheet		
		A	1/1		